



SOD91

hermetically sealed glass package; axial leaded; 2 leads

23 October 2018

Package information

1 Package summary

Terminal position code	A (axial)
Package type descriptive code	GALF2
Package type industry code	GALF2
Package style descriptive code	LALF (glass axial (leaded) long form)
Package body material type	L (glass)
Mounting method type	T (through-hole mount)
Issue date	09-06-1997
Manufacturer package code	SOD91

Table 1. Package summary

Parameter	Min	Nom	Max	Unit
package length	-	3	-	mm
package diameter	-	1.7	-	mm
actual quantity of termination	-	2	-	



2 Package outline

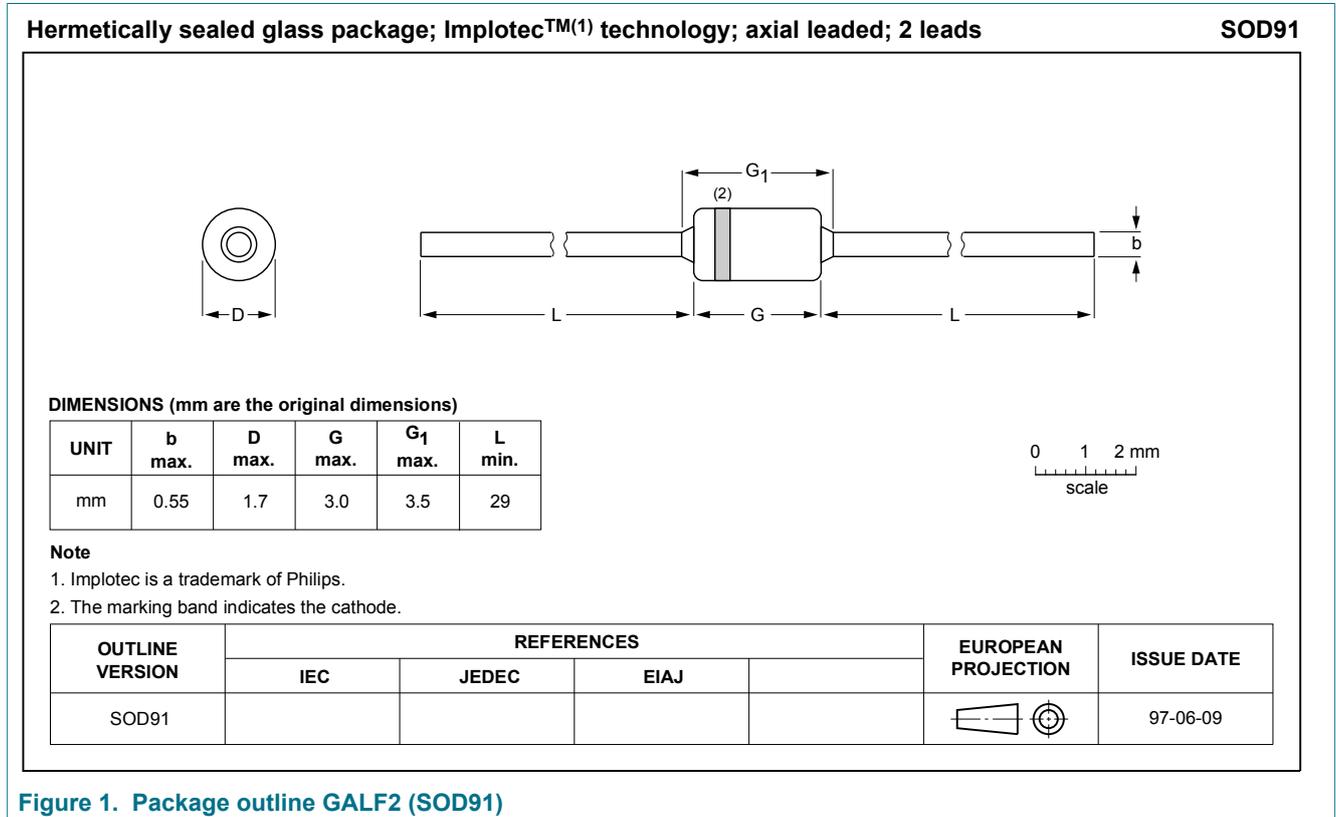


Figure 1. Package outline GALF2 (SOD91)

3 Legal information

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